

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

LC72131K PLL Frequency Synthesizer

Overview

The LC72131K and LC72131KMA are PLL frequency synthesizers for use in tuners in radio/cassette players. They allow high-performance AM/FM tuners to be implemented easily.

Features

- High speed programmable dividers
- FMIN: 10 to 160MHz pulse swallower (built-in divide-by-two prescaler)
- AMIN: 2 to 40MHz pulse swallower
 - 0.5 to 10MHz direct division
- IF counter
 - IFIN: 0.4 to 12MHz AM/FM IF counter
- Reference frequencies
 - Twelve selectable frequencies (4.5 or 7.2MHz crystal)
 - 100, 50, 25, 15, 12.5, 6.25, 3.125, 10, 9, 5, 3, 1kHz
- Phase comparator
 - Dead zone control
 - Unlock detection circuit
 - Deadlock clear circuit
 - Built-in MOS transistor for forming an active low-pass filter
- I/O ports
 - Dedicated output ports: 4 Input or output ports: 2 Support clock time base output
- Serial data I/O
 - Support CCB format communication with the system controller.

Continued on next page.

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- Operating ranges
- Supply voltage4.5 to 5.5V

• Operating temperature -40 to +85°C

- Packages
 - DIP22S(300mil) / MFP20J(300mil)

Specifications

Absolute Maximum Ratings at $Ta = 25^{\circ}C$, $V_{SS} = 0V$

Parameter	Symbol	Pins	Conditions	Ratings	Unit
Supply voltage	V _{DD} max	V _{DD}		-0.3 to +7.0	V
Maximum input voltage	V _{IN} 1 max	CE, CL, DI, AIN		-0.3 to +7.0	V
	V _{IN} 2 max	XIN, FMIN, AMIN, IFIN		-0.3 to V _{DD} +0.3	V
	V _{IN} 3 max	<u>101, 102</u>		-0.3 to +15	V
Maximum output voltage	V _O 1 max	DO		-0.3 to +7.0	V
	V _O 2 max	XOUT, PD		-0.3 to V _{DD} +0.3	V
	V _O 3 max	BO1 to BO4, IO1, IO2, AOUT		-0.3 to +15	V
Maximum output current	I _O 1 max	BO1		0 to 3.0	mA
	I _O 2 max	DO, AOUT		0 to 6.0	mA
	I _O 3 max	BO2 to BO4, IO1, IO2		0 to 10	mA
Allowable power dissipation	Pd max		Ta≤85°C [LC72131K]	350	mW
			Ta≤85°C [LC72131KMA]	180	mW
Operating temperature	Topr			-40 to +85	°C
Storage temperature	Tstg			-55 to +125	°C

Note 1: Power pins V_{DD} and V_{SS} : Insert a capacitor with a capacitance of 2,000pF or higher between these pins when using the IC.

Allowable Operating Ranges at Ta = -40 °C to +85 °C, $V_{SS} = 0V$

Dererssie	Currente e l	Dina	Conditions		Ratings		
Parameter	Symbol	Pins	Conditions	min	typ	max	unit
Supply voltage	V _{DD}	V _{DD}		4.5		5.5	V
Input high-level voltage	V _{IH} 1	CE, CL, DI		0.7V _{DD}		6.5	V
	V _{IH} 2	<u>101, 102</u>		0.7V _{DD}		13	V
Input low-level voltage	VIL	CE, CL, DI, IO1, IO2		0		0.3V _{DD}	V
Output voltage	V _O 1	DO		0		6.5	V
	V _O 2	BO1 to BO4, IO1, IO2, AOUT		0		13	V
Input frequency	fIN1	XIN	V _{IN} 1	1.0		8.0	MHz
	fIN2	FMIN	V _{IN} 2	10		160	MHz
	fIN3	AMIN	V _{IN} 3	2.0		40	MHz
	fIN4	AMIN	V _{IN} 4	0.5		10	MHz
	fIN5	IFIN	V _{IN} 5	0.4		12	MHz
Supported crystals	X'tal	XIN, XOUT	Note 1	4.0		8.0	MHz
Input amplitude	V _{IN} 1	XIN	fIN1	400		1500	mVrms
	V _{IN} 2-1	FMIN	f=10 to 130MHz	40		1500	mVrms
High-level clock pulse width to H CL [Figure 1][Figure 2] 160 ns	V _{IN} 2-2	FMIN	f=130 to 160MHz	70		1500	mVrms
Low-level clock pulse width	V _{IN} 3	AMIN	fIN3	40		1500	mVrms
	V _{IN} 4	AMIN	fIN4	40		1500	mVrms
	V _{IN} 5	IFIN	fIN5 (IFS=1)	40		1500	mVrms
	V _{IN} 6	IFIN	fIN5 (IFS=0)	70		1500	mVrms
Data setup time	tSU	DI, CL	Note 2	0.75			μs
Data hold time	tHD	DI, CL	Note 2	0.75			μs
Clock low-level time	tCL	CL	Note 2	0.75			μs
Clock high-level time	tCH	CL	Note 2	0.75			μs
CE wait time	tEL	CE, CL	Note 2	0.75			μs
CE setup time	tES	CE, CL	Note 2	0.75			μs
CE hold time	tEH	CE, CL	Note 2	0.75			μS
Data latch change time	tLC		Note 2			0.75	μs
Data output time	tDC	DO, CL	Differs depending				
	tDH	DO, CE	on the value of the pull-up resistor. Note 2			0.35	μS

Note 1: Recommended crystal oscillator CI values:

CI≤120Ω (For a 4.5MHz crystal)

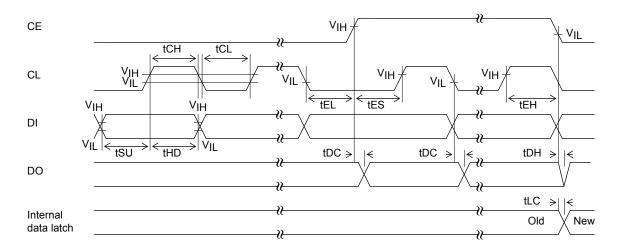
 $CI \le 70\Omega$ (For a 7.2MHz crystal)

The characteristics of the oscillation circuit depends on the printed circuit board, circuit constants, and other factors. Therefore we recommend consulting with the anufacturer of the crystal for evaluation and reliability. Note 2: Refer to "Serial Data Timing".

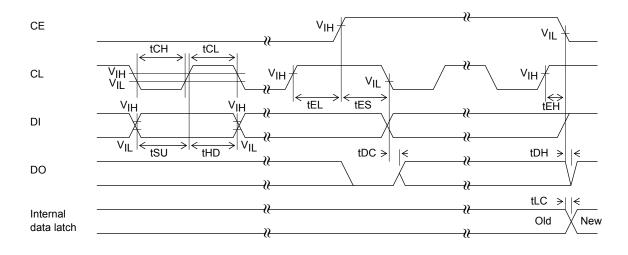
Electrical Characteristics in the Allowable Operating Ranges

Parameter	Symbol	Pins	Conditions		Ratings		unit
r aramotor	Cymbol	1 110	Conditionio	min	typ	max	unit
Built-in feedback resistance	Rf1	XIN			1.0		MΩ
	Rf2	FMIN			500		kΩ
	Rf3	AMIN			500		kΩ
	Rf4	IFIN			250		kΩ
Built-in pull-down resistor	Rpd1	FMIN			200		kΩ
	Rpd2	AMIN			200		kΩ
Hysteresis	VHYS	CE, CL, DI, IO1, IO2			0.1V _{DD}		V
Output high-level voltage	VOH	PD	I _O =1mA	V _{DD} -0.1	00		V
Output low-level voltage	V _{OL} 1	PD	I _O =1mA	00		1.0	V
	V _{OL} 2	BO1	I _O =0.5mA			0.5	V
	OL		I _O =1mA			1.0	v
	V _{OL} 3	DO	I _O =1mA			0.2	v
	- OL-		I _O =5mA			1.0	v
	V _{OL} 4	BO2 to BO4, IO1, IO2	I _O =1mA			0.2	V
	VOL-	0001,001,101,102					
			I _O =5mA			1.0	V
		AQUIT	I _O =8mA			1.6	V
	V _{OL} 5	AOUT	I _O =1mA AIN=1.3V			0.5	V
Input high-level current	I _{IH} 1	CE, CL, DI	V _I =6.5V			5.0	μA
	I _{IH} 2	<u>101, 102</u>	V _I =13V			5.0	μA
	I _{IH} 3	XIN	VI=VDD	2.0		11	μA
	I _{IH} 4	FMIN, AMIN	V _I =V _{DD}	4.0		22	μA
	I _{IH} 5	IFIN	V _I =V _{DD}	8.0		44	μA
	I _{IH} 6	AIN	V _I =6.5V			200	nA
Input low-level current	I _{IL} 1	CE, CL, DI	V _I =0V			5.0	μA
	I _{IL} 2	<u>101, 102</u>	V _I =0V			5.0	μA
	IIL3	XIN	V _I =0V	2.0		11	μA
	I _{IL} 4	FMIN, AMIN	V _I =0V	4.0		22	μA
	IIL2	IFIN	V _I =0V	8.0		44	μA
	IIL6	AIN	V _I =0V			200	nA
Output off leakage current	IOFF1	BO1 to BO4, AOUT, IO1, IO2	V _O =13V			5.0	μA
	IOFF2	DO	V _O =6.5V			5.0	μA
High-level three-state off leakage current	IOFFH	PD	V _O =V _{DD}		0.01	200	nA
Low-level three-state off leakage current	IOFFL	PD	V _O =0V		0.01	200	nA
Input capacitance	CIN	FMIN			6		pF
Current drain	I _{DD} 1	V _{DD}	X'tal=7.2MHz				
			f _{IN} 2=130MHz		5	10	mA
			V _{IN} 2=40mVrms				
	I _{DD} 2	V _{DD}	PLL block stopped				
			(PLL INHIBIT)		0.5		m^
			X'tal oscillator operating		0.5		mA
			(X'tal=7.2MHz)				
	I _{DD} 3	V _{DD}	PLL block stopped				
	55		X'tal oscillator			10	μA
			operating				

Serial Data Timing



When stopped with CL low



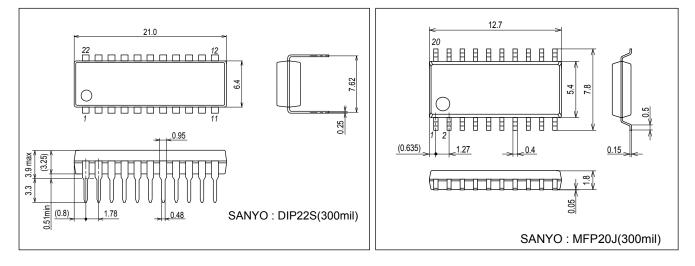
When stopped with CL high

Package Dimensions

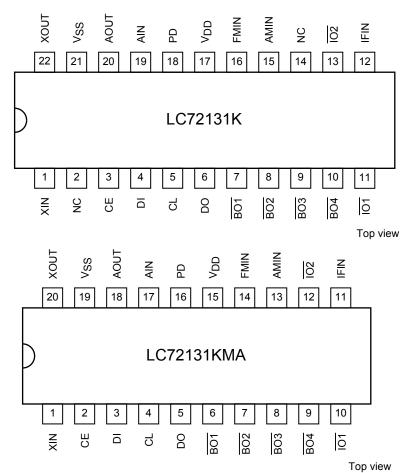
unit : mm (typ) 3059A [LC72131K]

Package Dimensions

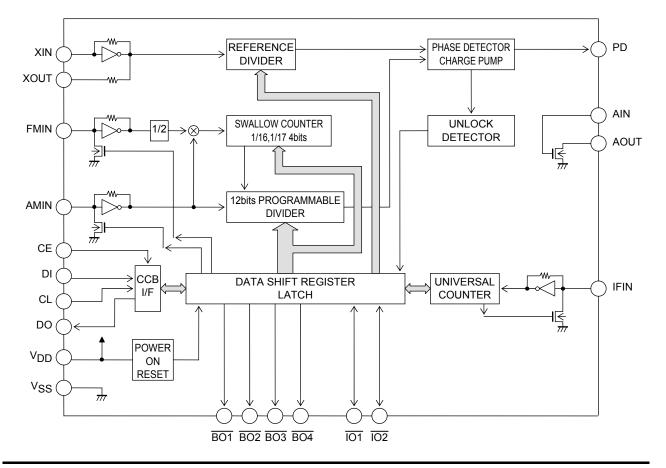
unit : mm (typ) 3445 [LC72131KMA]



Pin Assignments



Block Diagram



Pin Functions

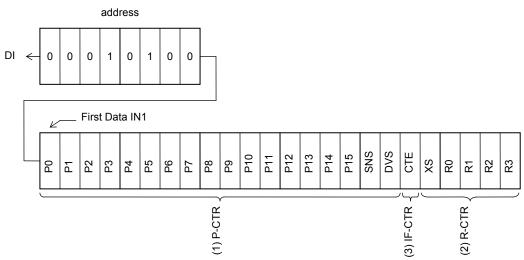
Oursela el	Pin	No.	Time	Functions	Oirea it as a firmentian
Symbol	LC72131K	LC72131KMA	Туре	Functions	Circuit configuration
XIN XOUT	1 22	1 20	X'tal OSC	Crystal resonator connection (4.5MHz/7.2MHz)	
FMIN	16	14	Local oscillator signal input	FMIN is selected when the serial data input DVS bit is set to 1. The input frequency range is from 10 to 160MHz. The input signal passes through the internal divide-by-two prescaler and is input to the swallow counter. The divisor can be in the range 272 to 65535. However, since the signal has passed through the divide-by-two prescaler, the actual divisor is twice the set value.	
AMIN	15	13	Local oscillator signal input	 AMIN is selected when the serial data input DVS bit is set to 0. When the serial data input SNS bit is set to 1: The input frequency range is 2 to 40MHz. The signal is directly input to the swallow counter. The divisor can be in the range 272 to 65535, and the divisor used will be the value set. When the serial data input SNS bit is set to 0: The input frequency range is 0.5 to 10MHz. The signal is directly input to a 12-bit programmable divider. The divisor can be in the range 4 to 4095, and the divisor used will be the value set. 	
CE	3	2	Chip enable	Set this pin high when inputting (DI) or outputting (DO) serial data.	□ <u></u> \$>>>
DI	4	3	Input data	Inputs serial data transferred from the controller to the LC72131K/KMA.	
CL	5	4	Clock	Used as the synchronization clock when inputting (DI) or outputting (DO) serial data.	
DO	6	5	Output data	Outputs serial data transferred from the LC72131K/KMA to the controller. The content of the output data is determined by the serial data DOC0 to DOC2.	
V _{DD}	17	15	Power supply	The LC72131K/KMA power supply pin (V _{DD} =4.5 to 5.5V) The power on reset circuit operates when power is first applied.	-
VSS	21	19	Ground	The LC72131K/KMA ground	-
BO1 BO2 BO3 BO4	7 8 9 10	6 7 8 9	Output port	Dedicated output pins The output states are determined by BO1 to BO4 bits in the serial data. Data: 0=open, 1=low A time base signal (8Hz) can be output from the BO1 pin. (When the serial data TBC bit is set to 1.) Care is required when using the BO1 pin, since it has a higher on impedance that the other output ports (pins BO2 to BO4).	
101	11 13	10 12	I/O port	 I/O dual-use pins The direction (input or output) is determined by bits IOC1 and IOC2 in the serial data. Data: 0=input port, 1=output port When specified for use as input ports: The state of the input pin is transmitted to the controller over the DO pin. Input state: Iow=0 data value	

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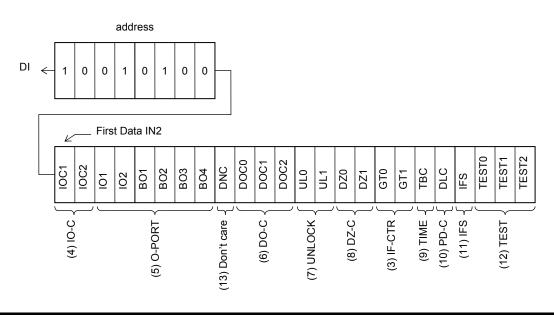
Oursels al	Pin	n No.	Turne	Furstions	Oinn it an firm which				
Symbol	LC72131K	LC72131KMA	Туре	Functions	Circuit configuration				
PD	18	16	Charge pump output	PLL charge pump output When the frequency generated by dividing the local oscillator frequency by N is higher than the reference frequency, a high level is output from the PD pin. Similarly, when that frequency is lower, a low level is output. The PD pin goes to the high impedance state when the frequencies match.					
AIN AOUT	19 20	17 18	LPF amplifier transistors	The n-channel MOS transistor used for the PLL active low-pass filter.					
IFIN	12	11	IF counter	Accepts an input in the frequency range 0.4 to 12MHz. The input signal is directly transmitted to the IF counter. The result is output starting the MSB of the IF counter using the DO pin. Four measurement periods are supported: 4, 8, 32, and 64ms.					

DI Control Data (Serial Data Input) Structure





[2] IN2 mode



Control Data Functions

No.	Control block/data					Functions		Related data
(1)	Programmable					able divider.		
	divider data	-			the MSB. T	he LSB changes de	pending on	
	P0 to P15	DVS and S	SNS. (*: do	on't care)				
		DVS	SNS	LSB	Divi	sor setting (N)	Actual divisor	
		1	*	P0		72 to 65535	Twice the value of the setting	
		0	1 0	P0 P4	2	72 to 65535 4 to 4095	The value of the setting The value of the setting	
					D4 is the		The value of the setting	
		Note: PU to	o P3 are ig	gnored whe	en P4 is the	LSB.		
	DVS, SNS	Selects the the input fr	-			I) for the programm	able divider, switches	
		DVS	SNS		Input pin		Input frequency range	
		1	*		FMIN		10 to 160MHz	
		0	1		AMIN		2 to 40MHz	
		0	0		AMIN		0.5 to 10MHz	
		Note: See	the "Progr	rammable	Divider Stru	cture" item for more	e information.	
(2)	Reference divider	Reference	frequency	(fref) sele	ction data.			
	data R0 to R3	R3	R2	R1	R0	Ref	erence frequency	
	RU to R3	0	0	0	0		100kHz	
		0	0 0	0	1		50 25	
		0	0	1	1		25	
		0	1	0	0		12.5	
		0	1	0	1		6.25	
		0	1	1	0		3.125	
		0	1 0	1 0	1 0		3.125 10	
			0	0	1		9	
		1	0	1	0		5	
		1	0	1	1		1	
		1	1	0	0		3	
		1	1	0	1		15	
		1	1	1	0		HIBIT + X'tal OSC STOP	
		1	1	1	1	* F	PLL INHIBIT	
		Note *: PL	L INHIBIT					
		Th	e program	mable divi	der block a	nd the IF counter bl	ock are stopped, the FMIN, AMIN,	
		and	d IFIN pins	s are set to	the pull-do	wn state (ground),	and the charge pump goes to the	
		hig	h impedar	nce state.				
	xs	Crystal res	conator se	lection				
	7.0	XS=0: 4						
		XS=1: 7						
		The 7.2	MHz frequ	ency is sel	ected after	the power-on reset.		
(3)	IF counter control	IF counter			data			IFS
	data	CTE=1: Co						
	CTE		ounter res					
	GT0, GT1		-		surement p			
		GT1	_	T0	Measure	ment time (ms)	Wait time (ms)	
		0		0		4	3 to 4	
		0		1 0		8 32	3 to 4 7 to 8	
				1		64	7 to 8	
		Noto: Soc	the "IF Co	unter Stru	cture" itom	for more information		

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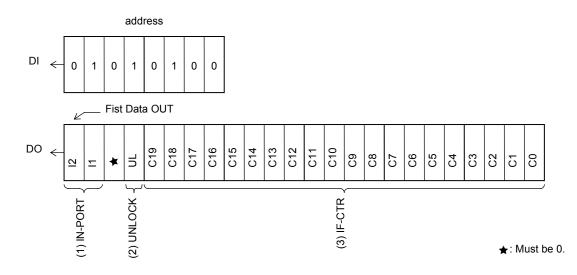
No.	ed from preceding page. Control block/data				Functions	2		Related data			
(4)	I/O port specification data IOC1, IOC2			on for the bidire 1=output mode	ectional pins IC						
(5)	Output port data BO1 to BO4 IO1, IO2	Data: 0=o	pen, 1=low	e output from t e is selected af		4, IO1 and IO2 output ports		IOC1 IOC2			
(6)	DO pin control data	Data that de	termines th	e DO pin outpu	ut			UL0, UL1			
	DOC0 DOC1	DOC2	DOC1	DOC0		Do pin state		CTE			
	DOC2	0 0 0 0	0 0 1 1	0 1 0 1	Open Low whe end-UC Open	en the unlock state is detected *1		IOC1 IOC2			
		1 0 0 Open 1 0 1 The IO1 pin state *2 1 1 0 The IO2 pin state *2 1 1 1 Open									
		The open st Note: 1. end									
		DO pin		Count start	? (2) C	ount end (3)CE: High					
		 (1) When end-UC is set and the IF counter is started (i.e., when CTE is changed from zero to one), the DO pin automatically goes to the open state. (2) When the IF counter measurement completes, the DO pin goes low to indicate the measurement completion state. 									
		(3) Note: 2. Goe	Depending es to the op	the DO pin goes to the open state. fied to be an output port. period (an IN1 or IN2 mode period wit							
		hig Als out). will								
(7)	Unlock detection		· •	(ϕ E) detection		ntrol data (DOC0 to DOC2). king PLL lock.		DOC0			
	data	A phase erro	or in excess	of the specifie	d detection wid	dth is seen as an unlocked state.		DOC1			
	UL0, UL1	UL1	UL0	φE detect	ion width	Detector output		DOC2			
		0 0 1	0 1 0	±0.	pped 0 55µs	Open ∳E is output directry ∳E is extended by 1 to 2ms					
		1	1	±1	1.11	↑					
		Note: In the	unlocked st	tate the DO pin	goes low and	the UL bit in the serial data becomes	zero.				

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ontinue	ed from preceding page.										
No.	Control block/data			F	unctions	Related data					
(8)	Phase comparator control data	Controls	s the phas	e comparator dead zone.							
	DZ0, DZ1	DZ1	DZ0	Dead zone mode							
	- ,	0	0	DZA							
		0	1	DZB							
		1	0	DZC							
		0 1 DZB 1 0 DZC 1 1 DZD Dead zone width: DZA <dzb< td=""> Setting TBC to one causes an 8Hz, 40% duty clock time base signal to be output from the BO1 pin. (BO1 data is invalid in this mode.)</dzb<>									
		Dead zor	ne width: D	ZA <dzb<dzc<dzd< td=""><td></td><td></td></dzb<dzc<dzd<>							
(9)	Clock time base	Setting T	BC to one	causes an 8Hz, 40% dut	y clock time base signal to be output from the $\overline{BO1}$	BO1					
	TBC	pin. (BO1	data is in	valid in this mode.)							
(10)	Charge pump control	Forcibly of	controls the	e charge pump output.							
	data	DLC	С	harge pump output							
	DLC	0		Normal operation							
		1									
		Note: If deadlock occurs due to the VCO control voltage (Vtune) going to zero and the VCO oscillator stopping, deadlock can be cleared by forcing the charge pump output to low and									
		setting Vtune to V_{CC} . (This is the deadlock clearing circuit.)									
(11)	IF counter control	This data	must be s	set 1 in normal mode.							
	data	IFS Th	ough if this	s value is set to zero, the	system enters input sensitivity degradation mode,						
	IFS	and the	e sensitivit	y is reduced to 10 to 30m	Vrms.						
		* See t	he "IF Cou	inter Operation" item for o	details.						
(12)	LSI test data	LSI test o	lata								
	TEST0 to 2	TEST0 -	٦								
		TEST1	These	values must all be set to	0.						
		TEST2									
		These test data are set to 0 automatically after the power-on reset.									
(13)	DNC	Don't car	e. This dat	a must be set to 0.							

DO Control Data (Serial Data Output) Structure

[3] OUT Mode



Control Data Functions

No.	Control block/data	Functions	Related data
(1)	I/O port data	Latched from the pin states of the $\overline{101}$ and $\overline{102}$ I/O ports.	IOC1
	12, 11	These values follow the pin states regardless of the input or output setting.	IOC2
		$I1 \leftarrow \overline{IO1}$ pin state \Box High: 1	
		$I2 \leftarrow \overline{IO2}$ pin state $_$ Low: 0	
(2)	PLL unlock data	Latched from the state of the unlock detection circuit.	ULO
	UL	$UL \leftarrow 0$: Unlocked	UL1
		UL \leftarrow 1: Locked or detection stopped mode	
(3)	IF counter binary	Latched from the value of the IF counter (20-bit binary counter).	CTE
	counter	C19 \leftarrow MSB of the binary counter	GT0
	C19 to C0	$C0 \leftarrow LSB$ of the binary counter	GT1

Serial Data I/O Methods

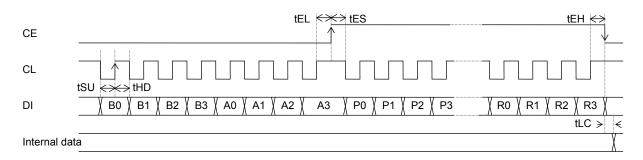
The LC72131K/KMA inputs and outputs data using the SANYO CCB (computer control bus) audio LSI serial bus format. This

LSI adopts an 8-bit address format CCB.

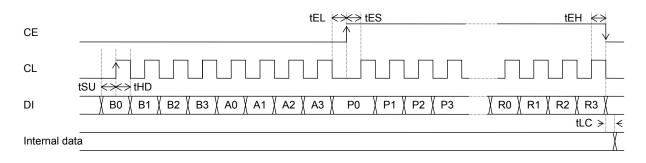
	I/O mode				Add	ress				Function								
	I/O mode	B0	B1	B2	B3	A0	A1	A2	A3	Function								
[1]	IN1 (82)	0	0	0	1	0	1	0	0	 Control data input mode (serial data input) 24 data bits are input. See the "DI Control Data (serial data input) Structure" item for details on the meaning of the input data. 								
[2]	IN2 (92)	1	0	0	1	0	1	0	0	Control data input mode (serial data input) 24 data bits are input								
[3]	OUT (A2)	0	1	0	1	0	1	0	0	 Data output mode (serial data output) The number of bits output is equal to the number of clock cycles. See the "DO Control Data (serial data output) Structure" item for details on the meaning of the output data. 								
$CE \qquad \qquad$																		
D	- -) В	οX	B1	∦ в2	2	В3	A0	X	A1 X A2 X A3 X X X X X X X X X X X X X X X X X								
D																		
(2) (1) CL: Normal high (2) CL: Normal low										λλ λλ ⊫ First Data OUT								

1. Serial Data Input (IN1/IN2) tSU, tHD, tES, tEH≥0.75µs tLC<0.75µs (1) CL - Normal high

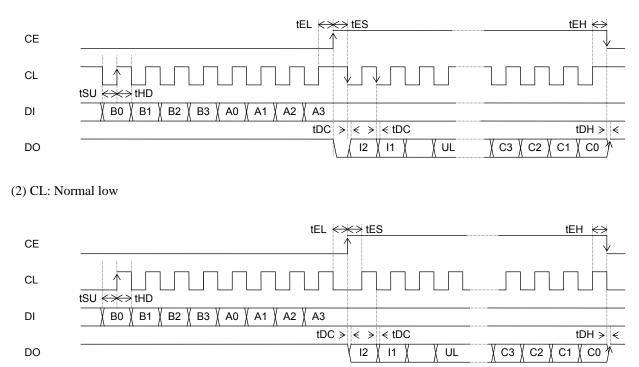
(1) CL: Normal high



(2) CL: Normal low

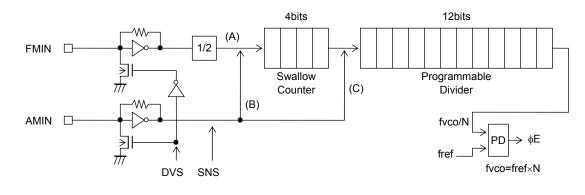


2. Serial Data Output (OUT) tSU, tHD, tEL, tES, tEH≥0.75µs tDC, tDH<0.35µs (1) CL: Normal high



Note: Since the DO pin is an N-channel open-drain pin, the time for the data to change (tDC and tDH) will differ depending on the value of the pull-up resistor and printed circuit board capacitance.

Programmable Divider Structure



	DVS	SNS	Input pin	Set divisor	Actual divisor: N	Input frequency range
(A)	1	*	FMIN	272 to 65535	Twice the set value	10 to 160MHz
(B)	1	1	AMIN	272 to 65535	The set value	2 to 40MHz
(C)	0	0	AMIN	4 to 4095	The set value	0.5 to 10MHz

*: Don't care

Programmable Divider Calculation Examples

(1) FM, 50kHz steps (DVS=1, SNS=*: FMIN selected)

FM RF=90.0MHz (IF=+10.7MHz)

FM VCO=100.7MHz

PLL fref=25kHz (R0 to R1=1, R2 to R3=0)

100.7MHz (FMVCO)÷25kHz (fref) ÷2 (FMIN: divide-by-two prescaler) =2014→07DE (HEX)

_	E	Ξ		_	[) 		_		7		_	() 									
0	1	1	1	1	0	1	1	1	1	1	0	0	0	0	0	*	1			1	1	0	0
PO	P	P2	P3	P4	P5	P6	P7	P8	6d	P10	P11	P12	P13	P14	P15	SNS	DVS	CTE	XS	R0	R1	R2	R3

(2) SW 5kHz steps (DVS=0, SNS=1: AMIN high-speed side selected)

SW RF=21.75MHz (IF=+450kHz)

SW VCO=22.20MHz

PLL fref=5kHz (R0=R2=0, R1=R3=1)

22.2MHz (SW VCO) ÷5kHz (fref) =4440→1158 (HEX)

	8	8			ę	5				1				1									
		<u> </u>				<u> </u>				<u> </u>				<u> </u>		-				-	-	-	
0	0	0	1	1	0	1	0	1	0	0	0	1	0	0	0	1	0			0	1	0	1
PO	£	P2	P3	P4	P5	P6	P7	P8	Бд	P10	P11	P12	P13	P14	P15	SNS	DVS	CTE	XS	R0	Ł	R2	R3

(3) MW 10kHz steps (DVS=0, SNS=0: AMIN low-speed side selected)

.

MW RF=1000kHz (IF=+450kHz)

MW VCO=1450kHz

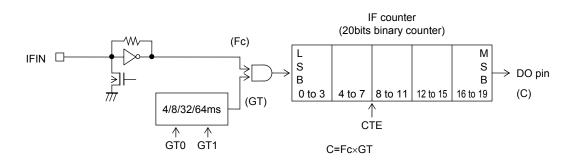
PLL fref=10kHz (R0 to R2=0, R3=1)

1450kHz (MW VCO) ÷10kHz (fref)=145→091 (HEX)

						1			Ş	9			(0									
						<u> </u>				<u> </u>				<u> </u>									
*	*	*	*	1	0	0	0	1	0	0	1	0	0	0	0	0	0			0	0	0	1
2	5	22	ŝ	4	5	မွ	2	80	ဂ္ဂ	5	5	12	13	4	15	SNS	SVC	Ë	ŝ	8	2	32	R3
	ш.	ш.		ш.	Ľ	Ľ	Ľ	"				ш.	Ľ			<u> </u>				ш.		ш	L

IF Counter Structure

The LC72131K/KMA IF counter is a 20-bit binary counter. The result, i.e., the counter's msb, can be read serially from the DO pin.



074	OTO	Measurement time								
GT1	GT0	Measurement time (GT) (ms)	Wait time (twu) (ms)							
0	0	4	3 to 4							
0	1	8	3 to 4							
1	0	32	7 to 8							
1	1	64	7 to 8							

The IF frequency (Fc) is measured by determining how many pulses were input to an IF counter in a specified measurement period, GT.

 $Fc = \frac{C}{GT}$ (C=Fc×GT) C: Count value (number of pulses)

IF Counter Frequency Calculation Examples

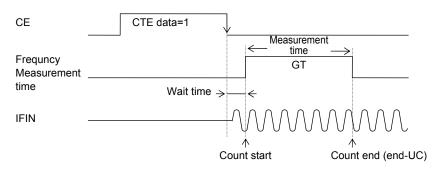
(1) When the measurement period (GT) is 32ms, the count (C) is 53980 hexadecimal (342400 decimal): IF frequency (Fc) =342400÷32ms=10.7MHz

			5				3			9				8				0				
					\sim				\sim				~				\sim				~	$\overline{}$
			0	1	0	1	0	0	1	1	1	0	0	1	1	0	0	0	0	0	0	0
2	Ξ	٦	C19	C18	C17	C16	C15	C14	C13	C12	C11	C10	ပ	ő	C7	C6	C5	5 7	ទ	ß	Ω	S

(2) When the measurement period (GT) is 8ms, the count (C) is E10 hexadecimal (3600 decimal): IF frequency (Fc) =3600÷8ms=450kHz

			0			0				E			1				0					
					<u> </u>				\sim				~				\sim					
			0	0	0	0	0	0	0	0	1	1	1	0	0	0	0	1	0	0	0	0
2	Ξ	٦	C19	C18	C17	C16	C15	C14	C13	C12	C11	C10	හි	ő	C7	90 Ce	C5	5	ទ	C3	ū	8

IF Counter Operation



Before starting the IF count, the IF counter must be reset in advance by setting CTE in the serial data to 0. The IF count is started by changing the CTE bit in the serial data from 0 to 1. The serial data is latched by the LC72131K/KMA when the CE pin is dropped from high to low. The IF signal must be supplied to the IFIN pin in the period between the point the CE pin goes low and the end of the wait time at the latest. Next, the value of the IF counter at the end of the measurement period must be read out during the period that CTE is 1. This is because the IF counter is reset when CTE is set to 0.

Note: When operating the IF counter, the control microprocessor must first check the state of the IF-IC SD (station detect) signal and only after determining that the SD signal is present turn on IF buffer output and execute an IF count operation. Autosearch techniques that use only the IF counter are not recommended, since it is possible for IF buffer leakage output to cause incorrect stops at points where there is no station.

IFIN minimum input se	ensitivity standard		f [MHz]
IFS	0.4≤f<0.5	0.5≤f<8	8≤f≤12
1: Normal mode	40mVrms (0.1 to 3mVrms)	40mVrms	40mVrms (1 to 10mVrms)
0: Degradation mode	70mVrms (10 to 15mVrms)	70mVrms	70mVrms (30 to 40mVrms)

Note: Values in parentheses are actual performance values presented as reference data.

Unlock Detection Timing

Unlock Detection Determination Timing

Unlocked state detection is performed in the reference frequency (fref) period (interval). Therefore, in principle, unlock determination requires a time longer than the period of the reference frequency. However, immediately after changing the divisor N (frequency) unlock detection must be performed after waiting at least two periods of the reference frequency.

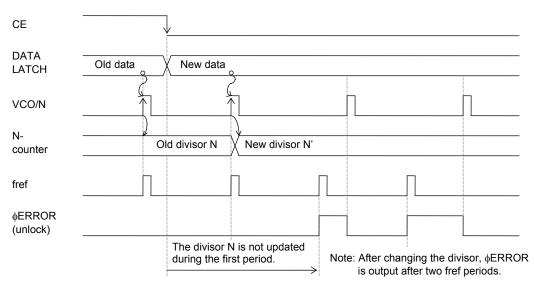


Figure 1 Unlocked State Detection Timing

For example, if fref is 1kHz, i.e., the period is 1ms, after changing the divisor N, the system must wait at least 2ms before checking for the unlocked state.

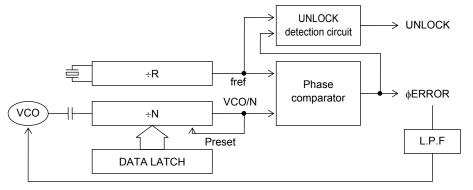


Figure 2 Circuit Structure

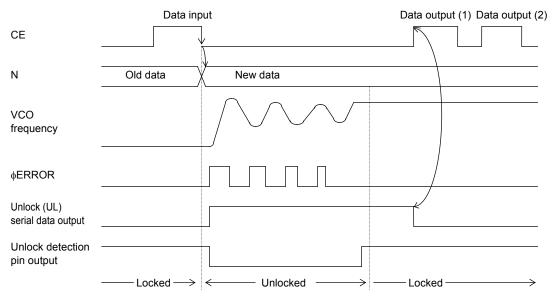


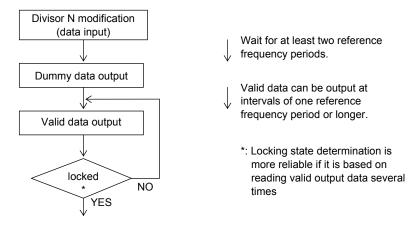
Figure 3

Unlocked State Data Output Using Serial Data Output

In the LC72131K/KMA, once an unlocked state occurs, the unlocked state serial data (UL) will not be reset until a data input (or output) operation is performed. At the data output (1) point in Figure 3, although the VCO frequency has stabilized (locked), since no data output has been performed since the divisor N was changed the unlocked state data remains in the unlocked state. As a result, even though the frequency has stabilized (locked), the system remains (from the standpoint of the data) in the unlocked state.

Therefore, the unlocked state data acquired at data output (1), which occurs immediately after the divisor N was changed, should be treated as a dummy data output and ignored. The second data output (data output (2)) and following outputs are valid data.

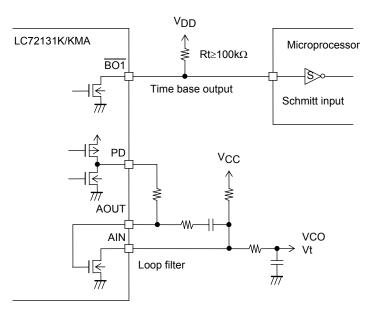
<Locked State Determination Flowchart Example>



Directly Outputting Unlocked State Data from the DO Pin (Set by the DO pin control data) Since the unlocked state (high=locked, low=unlocked) is output directly from the DO pin, the dummy data processing described in section 3 above is not required. After changing the divisor N, the locking state can be checked after waiting at least two reference frequency periods.

Clock Time Base Usage Notes

The pull-up resistor used on the clock time base output pin (BOI) should be at least 100k Ω . This is to prevent degrading the VCO C/N characteristics when a loop filter is formed using the built-in low-pass filter transistor. Since the clock time base output pin and the low-pass filter have a common ground internal to the IC, it is necessary to minimize the time base output pin current fluctuations and to suppress their influence on the low-pass filter. Also, to prevent chattering we recommend using a Schmitt input at the controller (microprocessor) that receives this signal.



Other Items

[1] Notes on the Phase Comparator Dead Zone

	5 on the 1	nuse comparator Deud	Lone	
DZ1	DZ0	Dead zone mode	Charge pump	Dead zone
0	0	DZA	ON/ON	0s
0	1	DZB	ON/ON	-0s
1	0	DZC	OFF/OFF	+0s
1	1	DZD	OFF/OFF	++0s

Since correction pulses are output from the charge pump even if the PLL is locked when the charge pump is in the ON/ON state, the loop can easily become unstable. This point requires special care when designing application circuits.

The following problems may occur in the ON/ON state.

(1) Side band generation due to reference frequency leakage

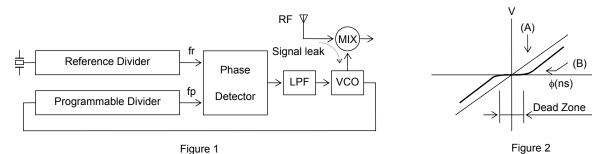
(2) Side band generation due to both the correction pulse envelope and low frequency leakage

Schemes in which a dead zone is present (OFF/OFF) have good loop stability, but have the problem that acquiring a high C/N ratio can be difficult. On the other hand, although it is easy to acquire a high C/N ratio with schemes in which there is no dead zone, it is difficult to achieve high loop stability. Therefore, it can be effective to select DZA or DZB, which have no dead zone, in applications which require an FM S/N ratio in excess of 90 to 100dB, or in which an increased AM stereo pilot margin is desired. On the other hand, we recommend selecting DZC or DZD, which provide a dead zone, for applications which do not require such a high FM signal-to-noise ratio and in which either AM stereo is not used or an adequate AM stereo pilot margin can be achieved.

Dead Zone

The phase comparator compares fp to a reference frequency (fr) as shown in Figure 1. Although the characteristics of this circuit (see Figure 2) are such that the output voltage is proportional to the phase difference ϕ (line A), a region (the dead zone) in which it is not possible to compare small phase differences occurs in actual ICs due to internal circuit delays and other factors (line B). A dead zone as small as possible is desirable for products that must provide a high S/N ratio.

However, since a larger dead zone makes this circuit easier to use, a larger dead zone is appropriate for popularlypriced products. This is because it is possible for RF signals to leak from the mixer to the VCO and modulate the VCO in popularly-priced products in the presence of strong RF inputs. When the dead zone is narrow, the circuit outputs correction pulses and this output can further modulate the VCO and generate beat frequencies with the RF signal.



[2] Notes on the FMIN, AMIN, and IFIN Pins

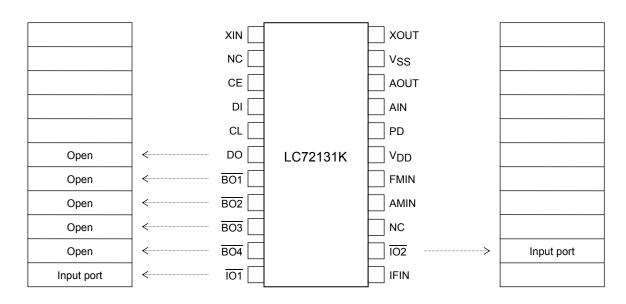
Coupling capacitors must be placed as close as possible to their respective pin. A capacitance of about 100pF is desirable. In particular, if a capacitance of 1000pF or over is used for the IF pin, the time to reach the bias level will increase and incorrect counting may occur due to the relationship with the wait time.

When using IF counting, always implement IF counting by having the microprocessor determine the presence of the IF-IC SD (station detect) signal and turn on the IF counter buffer only if the SD signal is present. Schemes in which auto-searches are performed with only IF counting are not recommended, since they can cause false detection where there is no signal due to overflow from the IF counter buffer.

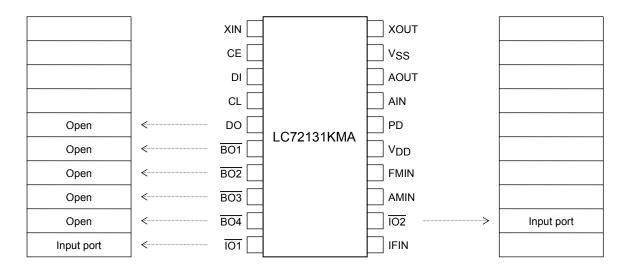
[4] DO Pin Usage Techniques

In addition to data output mode times, the DO pin can also be used to check for IF counter count completion and for unlock detection output. Also, an input pin state can be output unchanged through the DO pin and input to the controller.

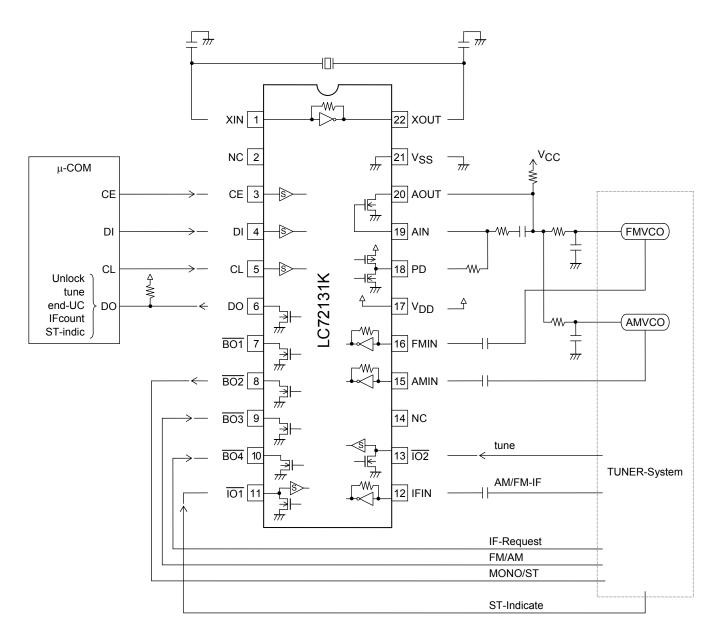
Pin States After the Power ON Reset [LC72131K]



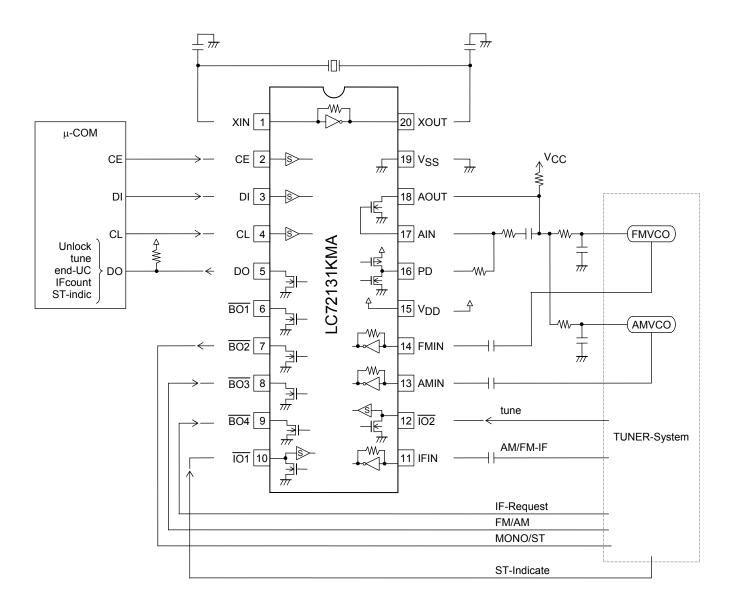
Pin States After the Power ON Reset [LC72131KMA]



Application System Example [LC72131K]



Application System Example [LC72131KMA]



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